

A WORLD OF BEST PRACTICES

FOR THE ELECTRONIC
COMPONENTS INDUSTRY

2021



Electronic Components Industry Association

A large, stylized globe on the right side of the page, composed of a network of blue and grey dots connected by thin lines, representing a global network or data flow.

GIPC

Agenda:

1. ECIA Update – [David Loftus](#), ECIA President and CEO
2. Top 50 Distributors Listing – [Dale Ford](#), ECIA Chief Analyst
3. Design Registration Study Phase 2 – [Don Elario](#)
4. Workplace – Post Pandemic – How is it changing? [Russ Dzielak](#)
5. Product Change Notification – Technology Advancements – [Don E.](#)
6. Environmental Compliance Advisors – [Don E.](#)
7. PIP 3.1, CA Prop 65, SCIP Database – [Don E.](#)
8. Growing the SME Pool
9. GIPC Succession Planning



**Global Industry
Pactices Committee**

ECIA

with

David Loftus

ECIA President and CEO



Electronic Components Industry Association

A large graphic on the right side of the slide depicts a globe. The globe is composed of a network of interconnected nodes and lines, representing a global network or data flow. The nodes are represented by small circles in various shades of blue and grey, connected by thin, light blue lines. The overall effect is a complex, web-like structure that covers the entire globe.

**Global Industry
Practices Committee**

Top 50 Distributors Listing

with

Dale Ford

ECIA Chief Analyst



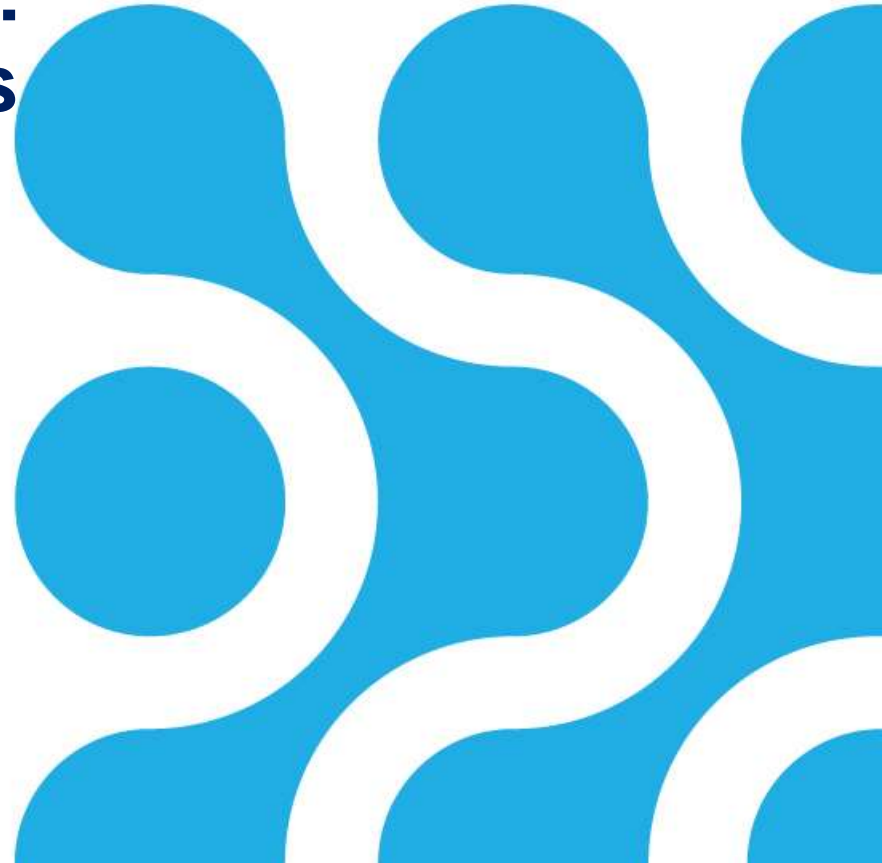
**Global Industry
Practices Committee**

Electronics Components: Distribution Perspectives

Dale Ford – Chief Analyst
May 24, 2021



Electronic Components Industry Association



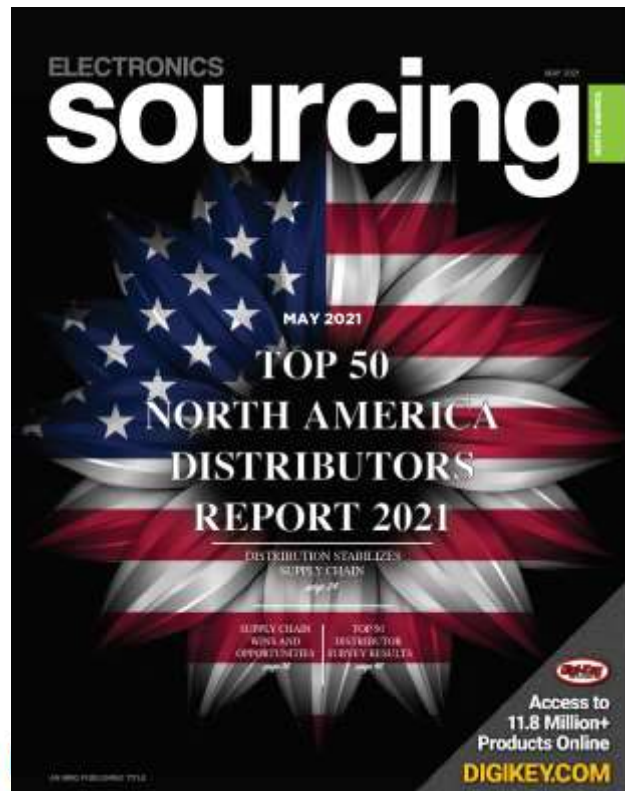


Top Americas
Authorized
Distributors

~ 2020 ~

Top 50 North America Authorized Distributors - 2020

ECIA / Electronics Sourcing Partnership



Distribution minimizes 2020 losses as it stabilizes supply chain

Amid pandemic turbulence North American distributors see revenues slide for second straight year but contain decline to -5.9% in volatile supply chain environment

The Top 50 North America Authorized Distributors

Rank 2020	Rank 2019	Company	2020 North America (\$ millions)	Growth 2020/2019 (%)	Share of Top 50 Total Sales (%)	North America Sales Share of Worldwide (%)	Type*	Sales Breakdown by Percent						Total Employees	Sales per Employee (\$ Millions)
								Active	Passive	Electro	Interconnect	Computer Products	Other		
1	1	Arrow Electronics, Inc. (2)	6,103.1	-13.7	28.84	30.3	1	76.0	3.4	2.4	8.3	8.0	2.0	6,088	1.72
2	2	Avnet (includes Formel) (2)	4,600.1	-9.2	21.74	26.1	1	76.0	5.3	3.4	11.5	2.5	1.6	3,868	1.20
3	3	Future Electronics (1)	2,000.0	-5.9	9.33	39.2	1	70.0	7.2	6.1	17.7	-	-	3,728	0.73
4	4	Digi-Key	1,700.1	-3.7	7.83	59.2	3	34.0	18.8	11.0	24.3	3.2	7.9	3,760	0.46
5	5	TTI	1,490.0	0.0	6.76	50.1	2	-	48.4	9.5	46.1	-	-	1,906	0.76
6	6	Mouser Electronics	942.5	7.2	4.40	46.4	3	45.0	17.0	11.0	22.0	-	5.0	1,850	0.51
7	7	OAC / Harbin	798.0	-4.4	3.71	82.7	2	-	-	15.8	84.2	-	-	735	1.08
8	8	Allied Electronics/RS Components	634.0	-5.9	2.98	26.6	1	0.7	0.8	33.0	22.1	8.7	34.7	800	0.79
9	9	Sager	313.0	-2.2	1.46	100.0	2	-	-	14.0	22.0	-	84.0	377	0.83
10	10	Master Electronics (1)	285.0	11.3	1.33	81.3	1	73.0	4.0	6.0	6.0	5.0	3.0	425	0.67

Industry growth drivers
– Beyond technology

Supply chain imbalances
and extending lead times

Securing the supply chain
becomes a top priority

The value of
distribution
highlighted

Shipping, logistics
and freight – oh my!

Reshaping markets in
the near and long-term

Transformations in workplaces
and workforce support

Digital technology – Supply
Chain wins and opportunities

Connect. Influence. Optimize.

The Top 50

Rank 2020	Rank 2019	Company	2020 North America (\$ Millions)
1	1	Arrow Electronics, Inc. (2)	6,183.1
2	2	Avnet (Includes Farnell) (2)	4,660.1
3	3	Future Electronics (1)	2,000.0
4	4	Digi-Key	1,700.1
5	5	TTI	1,450.0
6	6	Mouser Electronics	942.6
7	7	DAC / Hellind	796.0
8	8	Allied Electronics/RS Components	634.0
9	9	Sager	313.0
10	10	Master Electronics (1)	285.0
11	11	Bisco Industries, Inc.	218.8
12	14	WPG Americas Inc.	200.0
13	12	Powell Electronics	190.0
14	13	PEI-Genesis (3)	180.0
15	15	Electro Enterprises	146.8

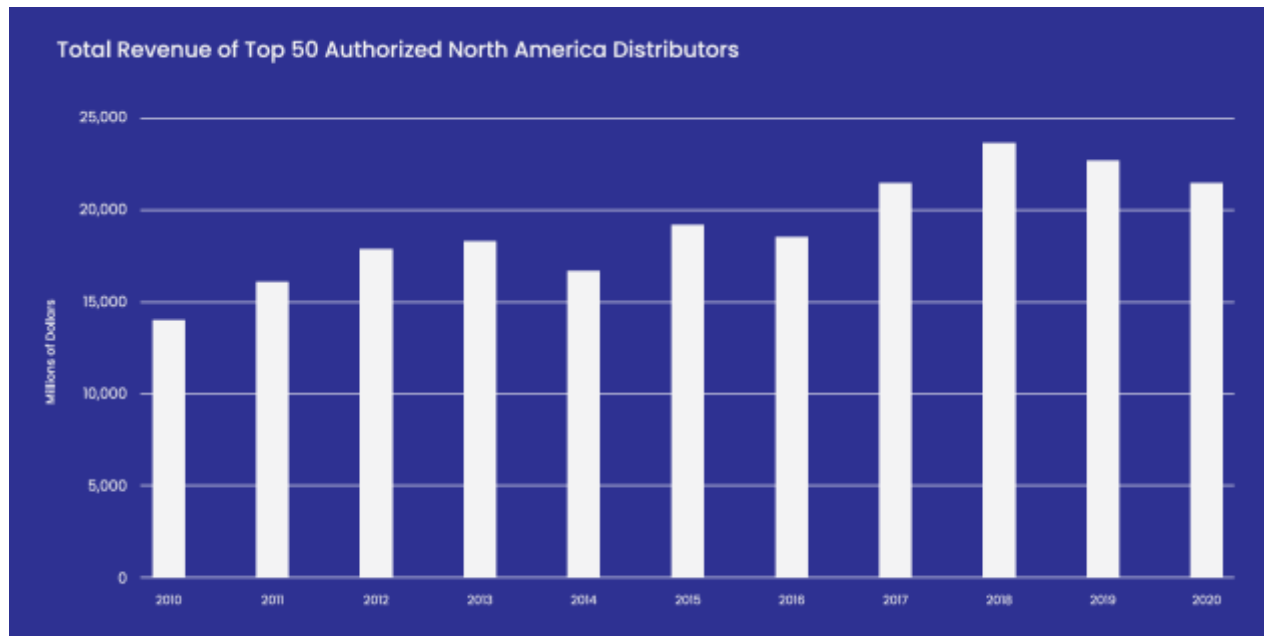
16	19	BJG Electronics, Inc.	123.6
17	18	RFMW	112.0
18	16	Carlton-Bates	100.0
19	17	Hughes Peters	90.0
20	20	Flame Enterprises	77.3
21	21	Steven Engineering	75.1
22	22	Peerless Electronics (1)	71.5
23	23	NEP Electronics (1)	65.8
24	24	Marsh Electronics, Inc.	58.5
25	25	Richardson Electronics (2)	58.2
26	26	Symmetry Electronics	55.0
27	32	Area51 Electronics	46.6
28	28	Edge Electronics (1)	46.2
29	27	SMD, Inc.	38.8
30	31	Falcon Electronics	38.5
31	29	Agility EMS (Gopher Electronics) (1)	36.5
32	30	Fuses Unlimited (1)	34.8
33	34	CDM Electronics (1)	34.0

34	35	Brevan Electronics	32.1
35	33	Beyond Components (1)	29.1
36	39	Diverse Electronics	26.3
37	37	Powertech Controls (1)	25.2
38	41	NASCO Aerospace & Electronics	25.0
39	36	PCX (1)	25.0
40	38	Masline Electronics (1)	24.7
41	47	Bluff City Electronics	22.7
42	40	Cumberland Electronics (1)	22.1
43	49	Flip Electronics	21.3
44	44	Microwave Components, LLC	19.5
45	42	Kensington Electronics	19.0
46	43	PUI (Projections Unlimited, Inc.)	18.8
47	45	Benchmark Connector Corporation	18.0
48	48	Sherburn	16.9
49	46	March Electronics (1)	15.8
50	50	East Coast Microwave (1)	14.8
TOTAL TOP 50			21,438

(1) ECIA Estimate for Total North America Sales and Sales Breakdown • (2) ECIA Estimate for Sales Breakdown • (3) ECIA Estimate for Total North America Sales

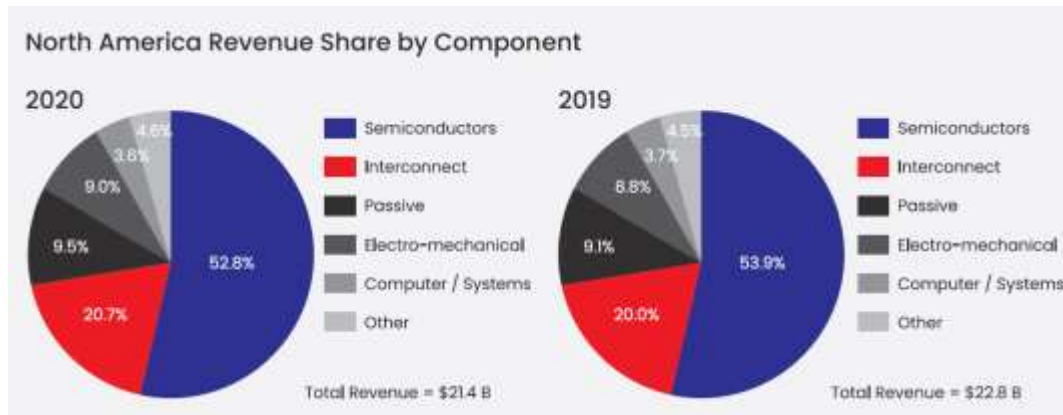
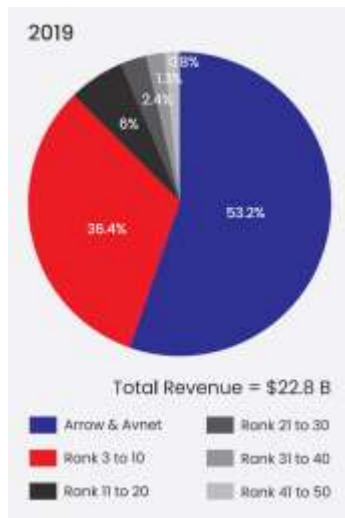
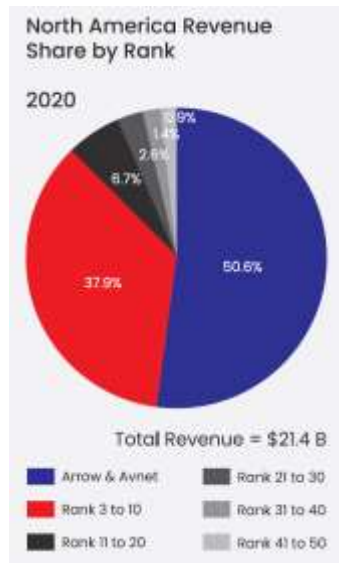
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Distribution Revenue Growth and Geographic Share

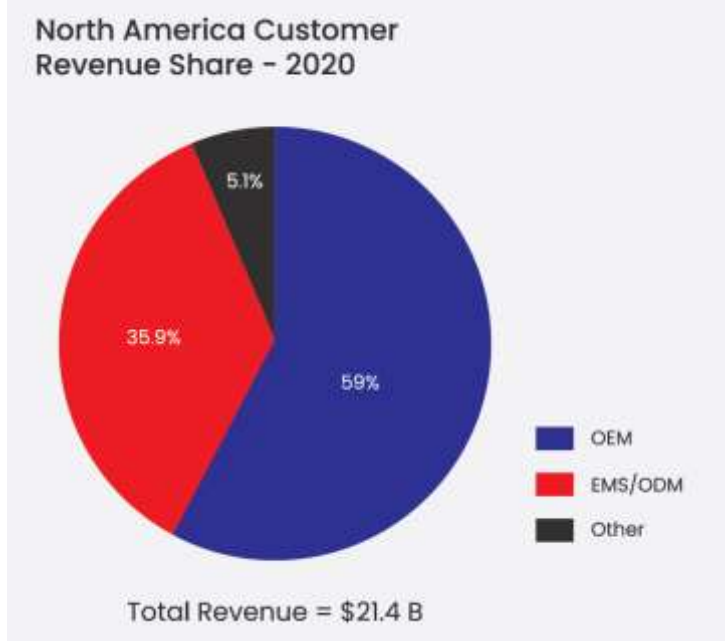
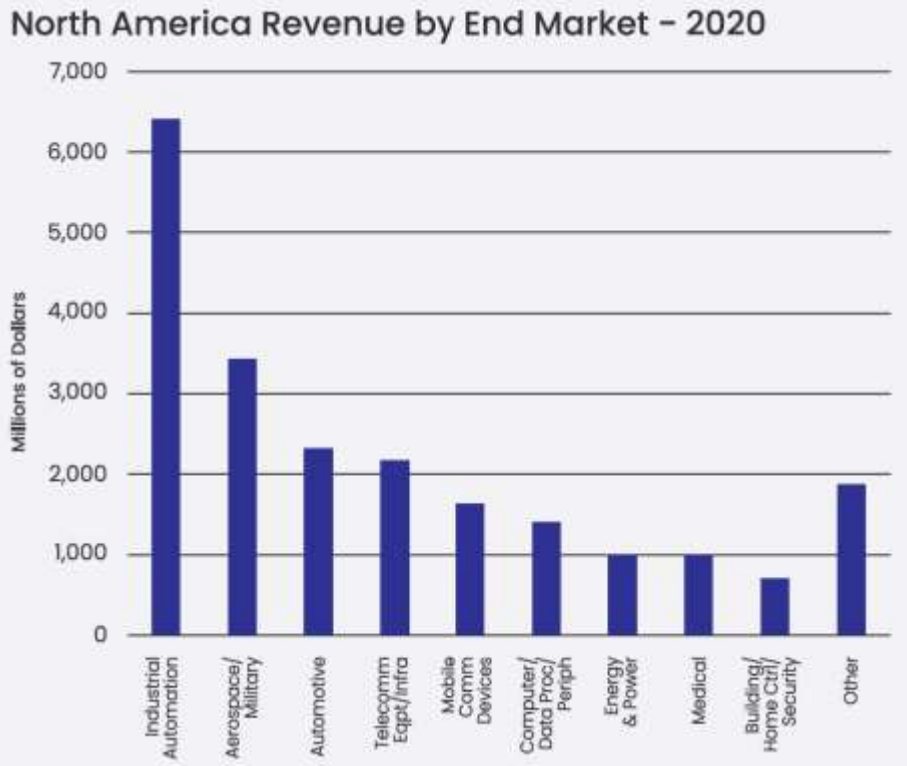


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Revenue Share by Component and Rank

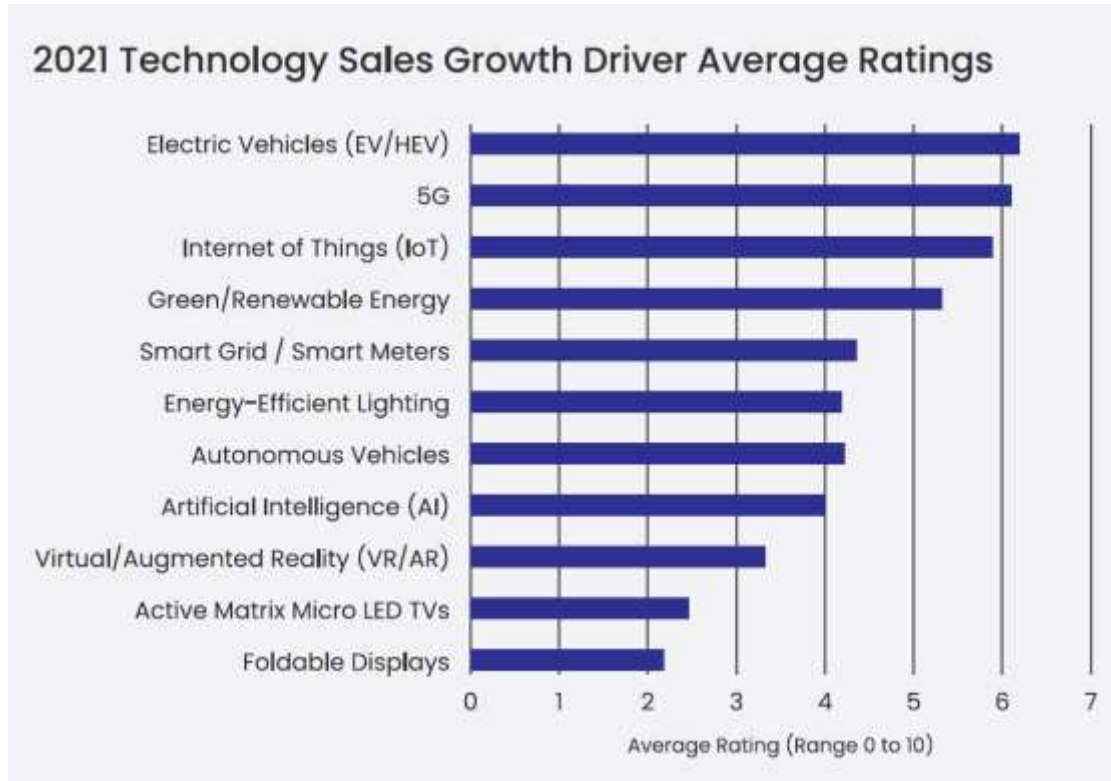


Revenue by Customer and End Market



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Electronic Component Distribution Growth Drivers



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Top 25/50 Worldwide Authorized Distributors - 2020

Next ECIA / Electronics Sourcing Partnership

- Opportunity to leverage research from North America Top 50
- Planned publication in advance of EDS in Las Vegas
- Fills need for more complete worldwide view of distribution
- Top distributor research supports DTAM research efforts

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Sizing Americas DTAM by Region

~ Developing Research ~

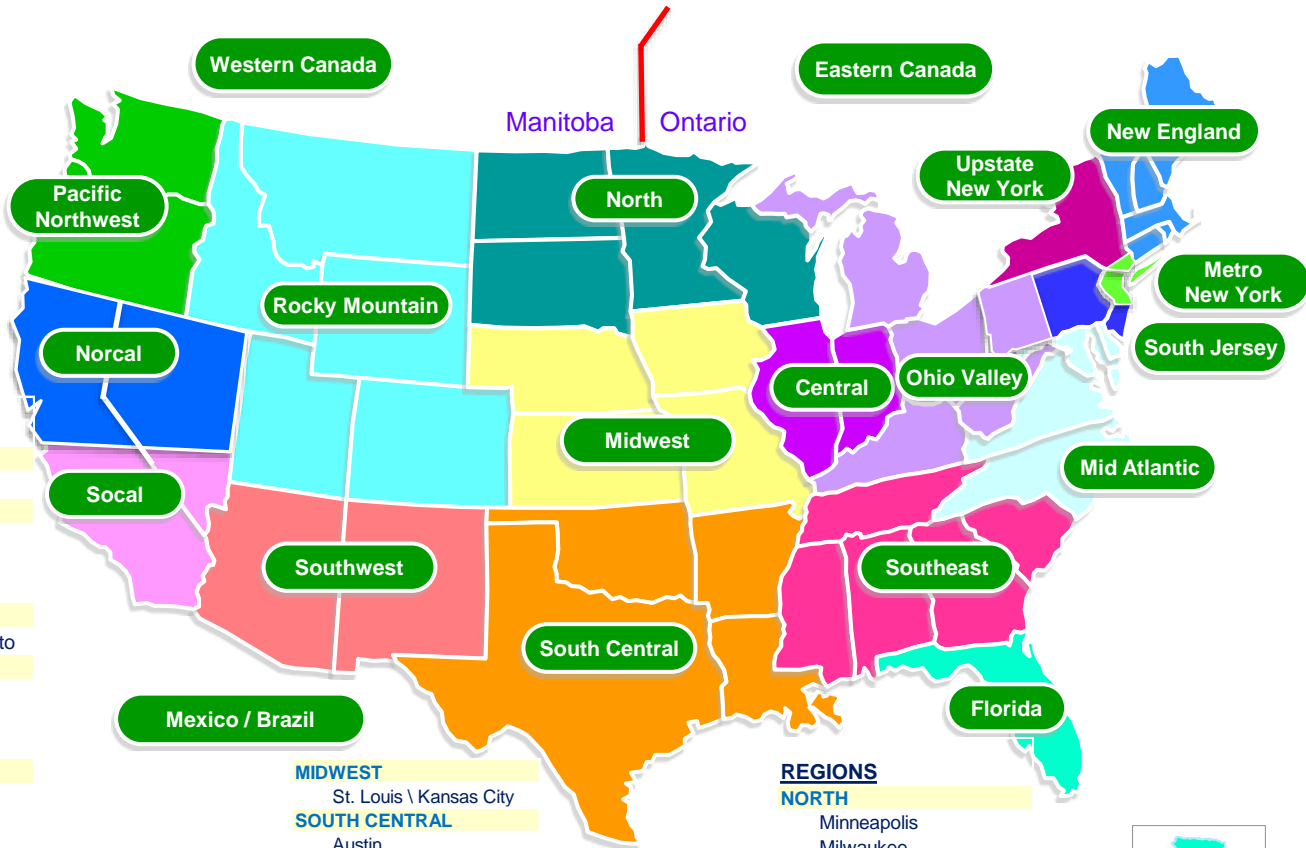
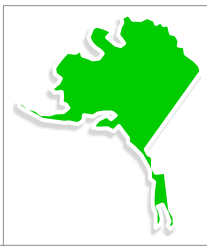


Americas DTAM research initiatives

Americas DTAM segmented by major regions – 2020

- Effort to develop entirely new research area – builds on top 50 distributor research
 - Previous data developed by ERA many years ago and based primarily on top level estimates
- Regional data based on:
 - Americas Total DTAM estimate for major component markets from Top 50 research
 - Survey input analysis (12 to 18 data points for every market in every region)
 - Comparison with Budde Marketing aggregated data for regions (mapped by zip codes)
 - Final estimates based on data sources above and balancing
- Decision by Board of Directors to deliver report to all ECIA members
 - Desire to promote visibility and enhance/improve future research
- Active feedback and discussions already taking place

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REGIONS

SOUTHWEST

Phoenix

SOCAL

Irvine
Los Angeles
San Diego

NORCAL

San Jose / Sacramento

PACIFIC NORTHWEST

Portland
Seattle

EASTERN CANADA

Ottawa
Montreal
Toronto

WESTERN CANADA

Vancouver / Calgary

MEXICO \ BRAZIL

MIDWEST

St. Louis \ Kansas City

SOUTH CENTRAL

Austin
Dallas \ Tulsa
Houston

ROCKY MOUNTAIN

Denver
Salt Lake City

REGIONS

NORTH

Minneapolis
Milwaukee

CENTRAL

Chicago

OHIO VALLEY

Cleveland
Dayton
Detroit
Indianapolis
Pittsburg

REGIONS

NEW ENGLAND

Boston
Connecticut

UPSTATE NEW YORK

Rochester

METRO NEW YORK

Long Island
North New Jersey

SOUTH JERSEY

South New Jersey

MID ATLANTIC

Baltimore / Washington
Raleigh

SOUTHEAST

Atlanta
Huntsville

FLORIDA

Florida
Puerto Rico



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Electronic Components Industry Association

Americas DTAM Data Segmented by Major Regions

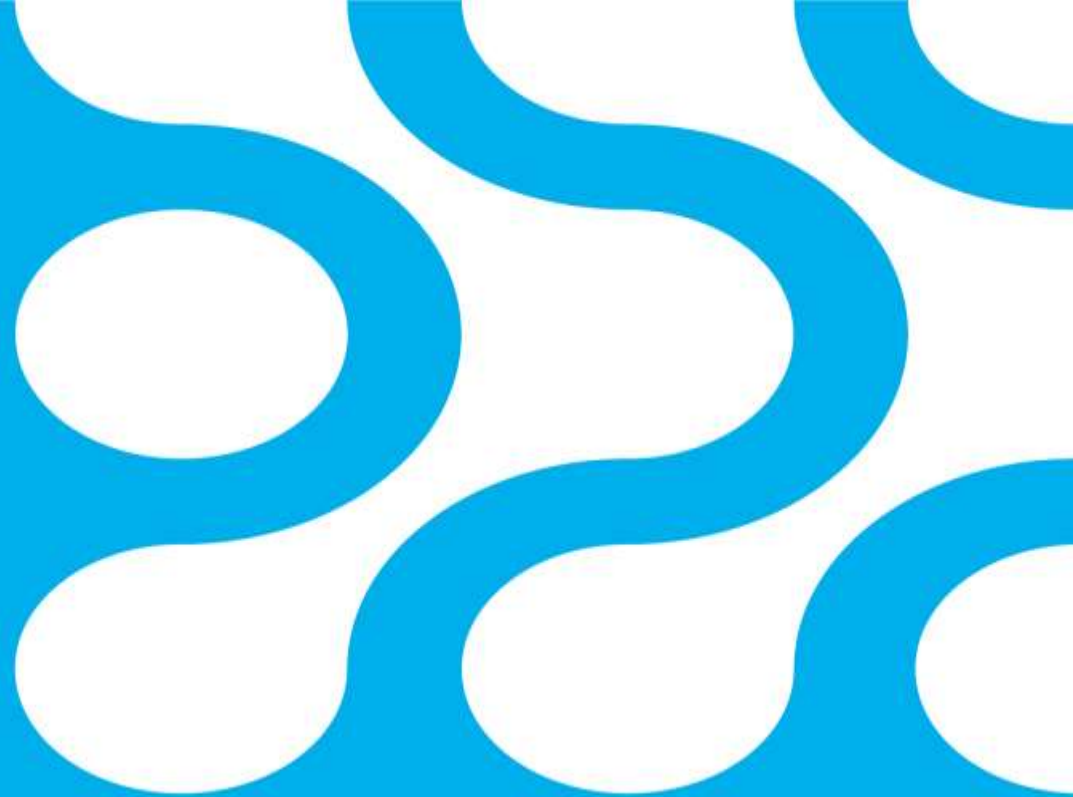
Americas Annual DTAM Share by Geographic Region for 2020

	Region	Semi-conductors	Passives	Interconnect/ Connector	Electro-Mechanical	Total DTAM
A	New England	-	-	-	-	-
B	Upstate New York	-	-	-	-	-
C	Metro New York	-	-	-	-	-
D	South Jersey	-	-	-	-	-
E	Mid Atlantic	-	-	-	-	-
F	Southeast	-	-	-	-	-
G	Florida	-	-	-	-	-
H	North	-	-	-	-	-
I	Central	-	-	-	-	-
J	Ohio Valley	-	-	-	-	-
K	Midwest	-	-	-	-	-
L	South Central	-	-	-	-	-
M	Rocky Mountain	-	-	-	-	-
N	Southwest	-	-	-	-	-
O	Socal	-	-	-	-	-
P	Norcal	-	-	-	-	-
Q	Pacific Northwest	-	-	-	-	-
R	Eastern Canada	-	-	-	-	-
S	Western Canada	-	-	-	-	-
T	Mexico \ Brazil	-	-	-	-	-
	TOTAL (FIXED)	11,350.0	2,065.0	4,450.0	2,090.0	19,955.0

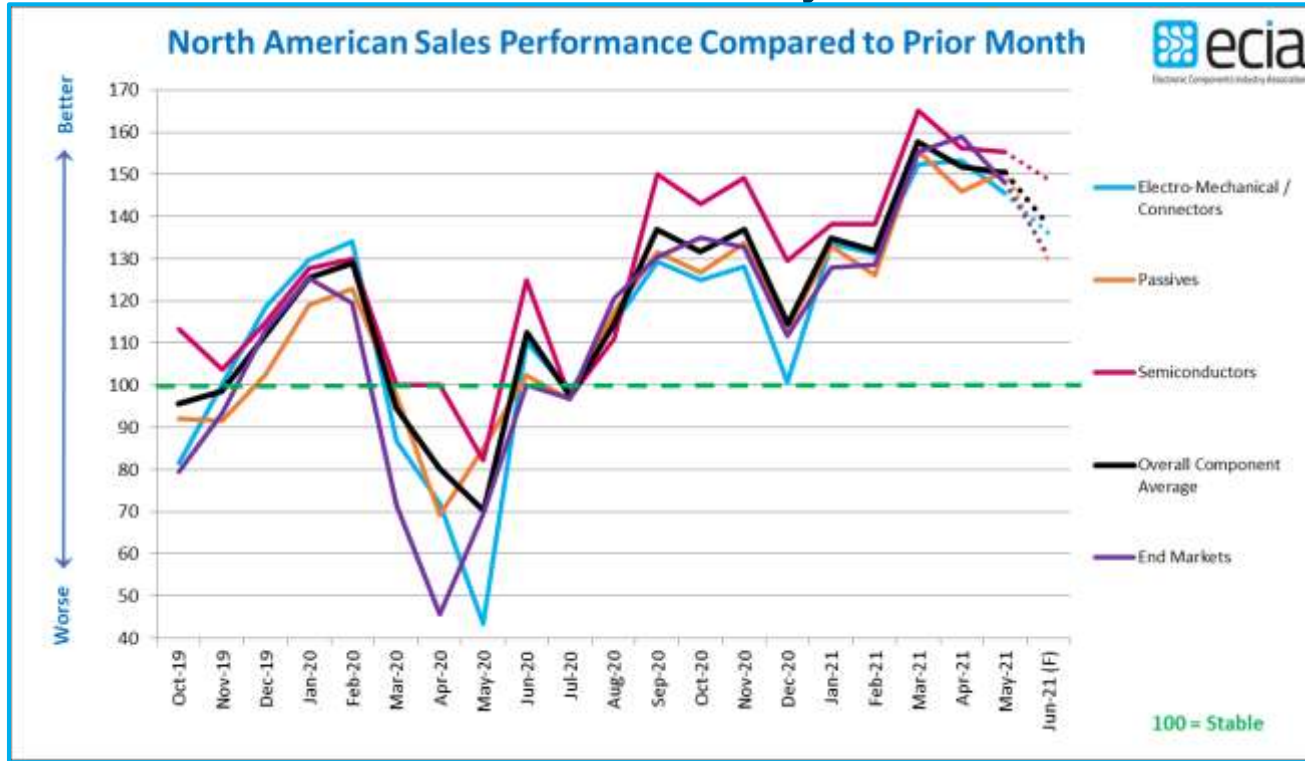
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Market Status

~ Update ~



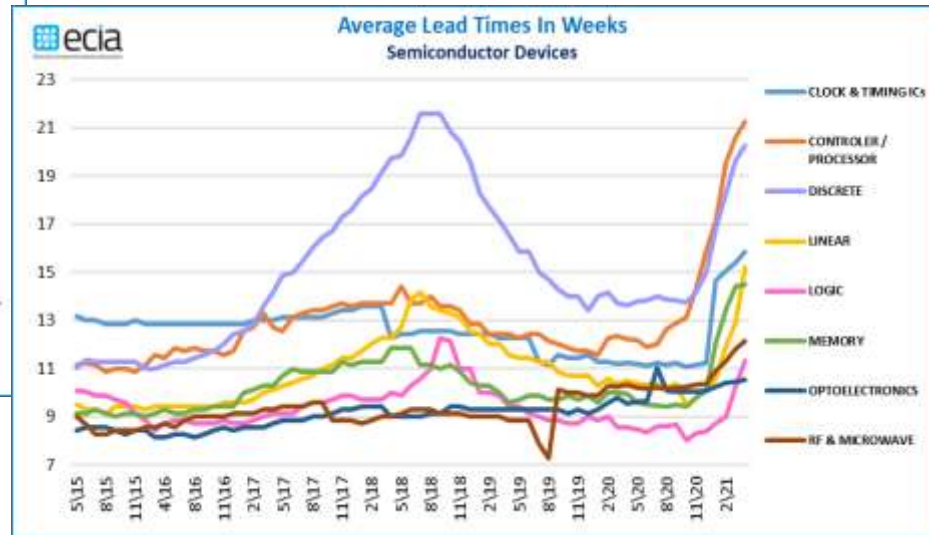
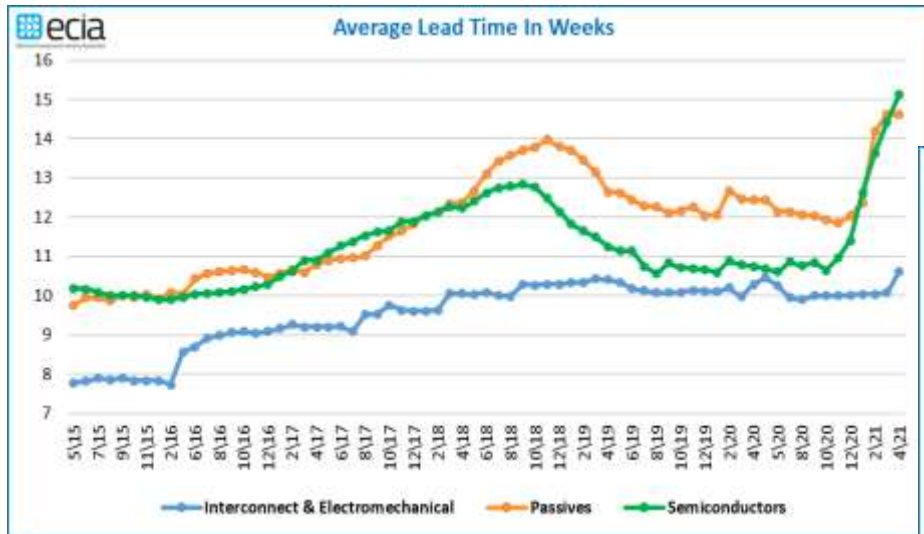
North America Sentiment Survey Trends



Source: ECIA Electronic Component Sales Trends Survey

Connect. Influence. Optimize.

Record Setting Lead Time Pressure



Connect. Influence. Optimize.

Semiconductor Revenue Growth Cycle

- Quarter-over-Quarter growth surges toward 20% with no sign of weakness
- Annual revenue cycle trends up starting September 2019
- Annual revenue growth breaks positive in August 2020
- Memory pricing slump results in 6 month pause in growth trend
- Strong pent-up demand and technology drivers
- Accelerating growth in 2021

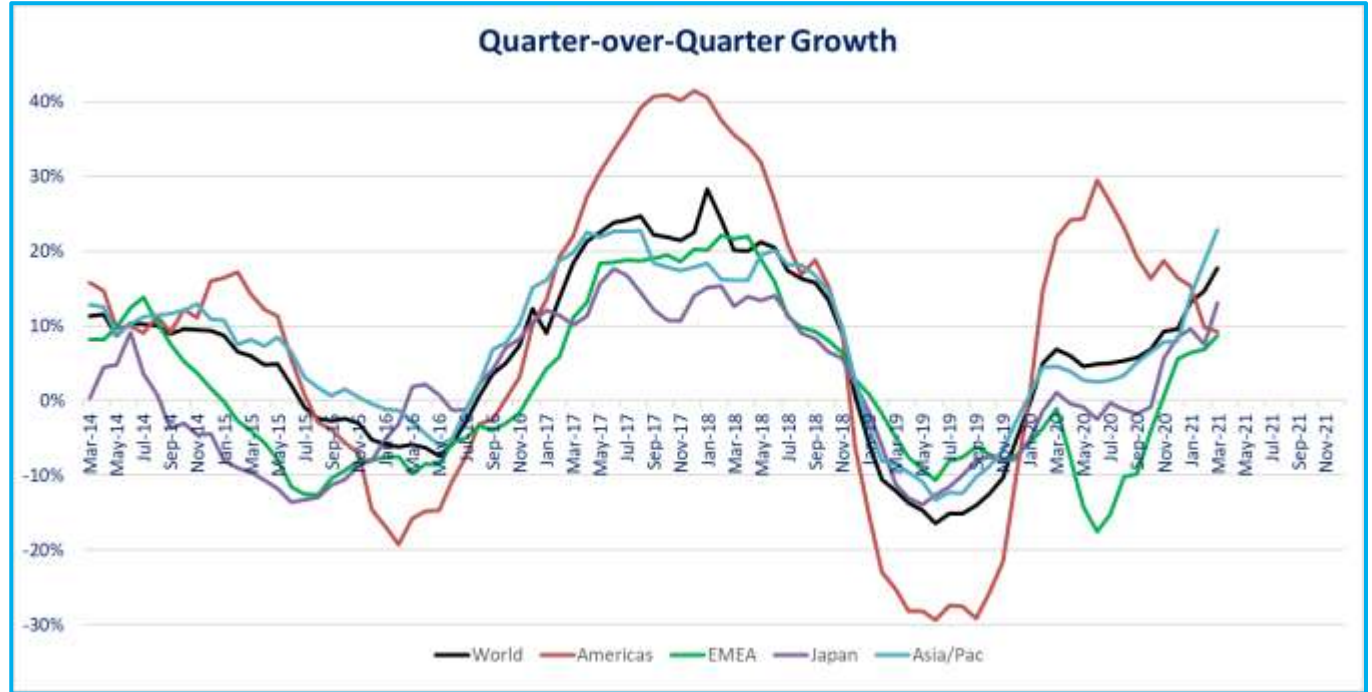


Source – WSTS

Connect. Influence. Optimize.

But What About the Americas?

- Counter-cyclical trend downward starting in summer 2020
- High memory mix in Americas contributes to weakness
- Automotive limitations also playing a role?
- Slight indication of bottoming out in last month of data



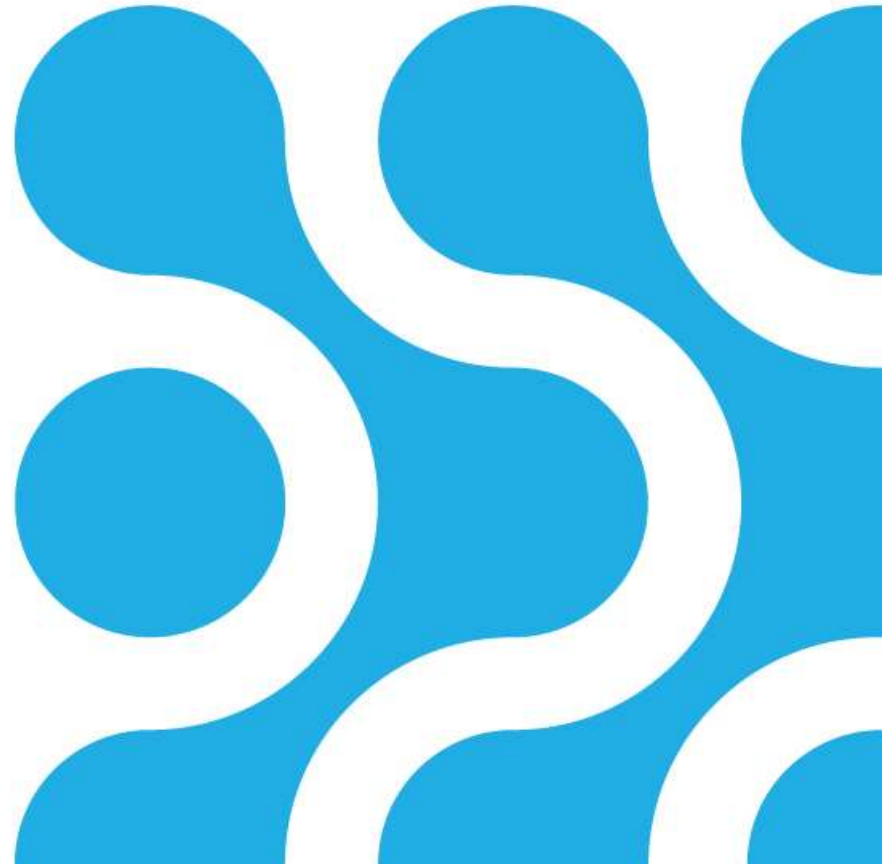
Source – WSTS

Thank you!

Dale Ford – Chief Analyst
dford@ecianow.org



Electronic Components Industry Association



Design Registration Study Phase 2 Desired – Future State

Don Elario

VP Industry Practice



Electronic Components Industry Association

A large graphic on the right side of the slide depicts a globe. The globe is composed of a network of blue and grey dots connected by thin lines, representing a global network or data flow. The text "Global Industry Practices Committee" is overlaid on the globe in a blue, sans-serif font, with the words "Global Industry" on one line and "Practices Committee" on the line below, both underlined.

Global Industry
Practices Committee

Phase 2 SME Work Group

Sales Marketing

- Vienna Ding – ON Semiconductor
- Nicole Gruttadaurio – Luscombe Eng
- Corban Graham – Maxim Integrated
- Neil Hutchinson – Murata
- Joyce Nardone – Allegro
- Philippe Vauclair – Future
- Bob Ford – Trek-Tech

Sales and Marketing representatives who have worked with the design registration process in the field. Mix of knowledge with semiconductors, inter-connect and electro-mechanical and passive.

Business Operations

- Josh Kovalik – TE Connectivity
- Jaime Sharp – AVX
- Kaye Eicher – Vishay
- Chris Reginato – Avnet NA
- Simone Blumoser – EBV Avnet EU
- Josh Levine – RFMW
- Mark Howard – TTI
- Tobi Cornell – Kruvand

Business operations representatives who have both internal / external experience with process steps in the design registration process. Mix of knowledge with semiconductors, inter-connect and electro-mechanical and passive.

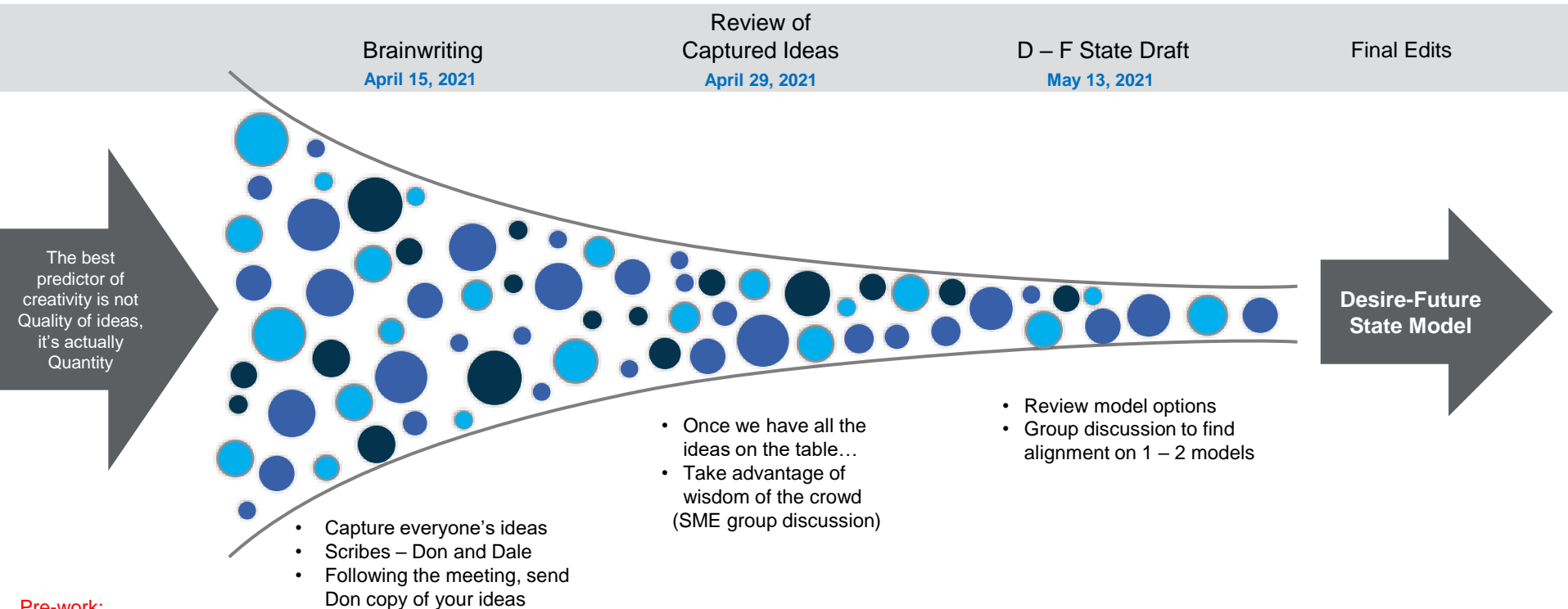
IT – Systems Development

- Manufacturer
- Distributor
- Additional individuals will be utilized on an as needed basis.

IT, systems development, technical representatives who have worked with and understanding the design registration process flow and system requirements. Knowledge of trending technologies that could support modernization.

- All subject matter experts should be open minded, creative, out-of-the-box thinkers, good listeners, ability to find compromise and have a proven track record of displaying these skills. Work group chemistry will be important to our success.

Desired – Future State Model Plan



Pre-work:

- Watch Adam Grant Video
- Let the work group come-up with ideas separately
- Write down 10-20 ideas for April 15 call

Global Industry Practices Committee (GIPC)

API

What is an API?

- Application Programming Interface (API)
- A means of communication
 - App to app
 - Automated
- A description of the communication methods allowed
 - Requesting information
 - Sending information
 - Updating information
- The mechanisms supporting those interactions



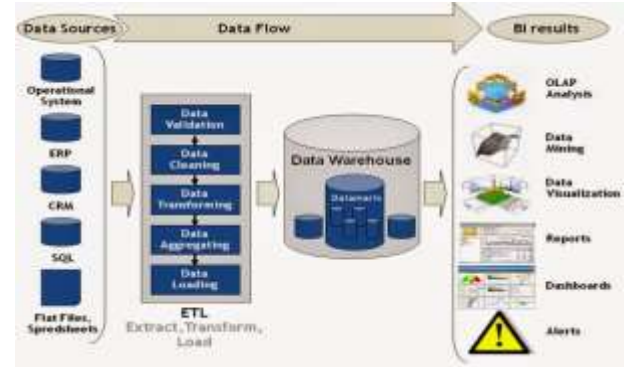
28/24

NEURAL

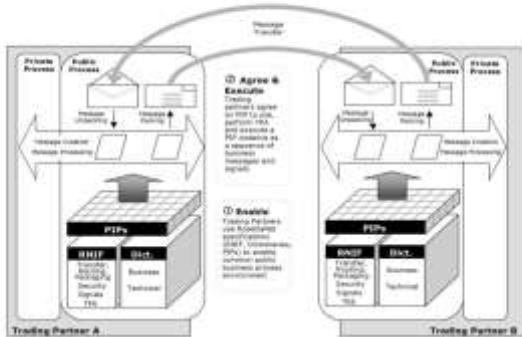
Our Solutions
Lead The World In
Artificial Intelligence
Excellence.

Work(s) with SAP, Epic, Oracle,
Siemens, QAD, to name a few.
We integrate with ERP, EHR, MRP, PLM,
HRM, MES, and CRM systems.

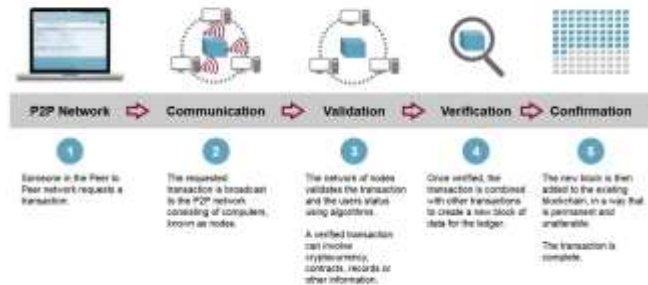
ETL



RosettaNet 구현을 위한 RNIF 규격



Blockchain Process Steps



Blockchain

Global Industry Practices Committee (GIPC)



Design Registration Roadmap

2020

Q1

Introduction

Manufacturing Council Discussions
Council Task Team
Scoping Document

Q2

Structure

ECIA, GEDA, ERA
Executive Steering Committee
SME Work Group & Launch

Q3

Framework

In/Out of Scope – Current State
Survey Questions
Part-1 Survey

Q4

Phase 1 End

Part-2 Survey
Deliverables:
Master Index – Survey Results
Current State Assessment
Executive Summary

2021

Q1

Phase 2 Start

Deliverable Review, Publication
Adjustments to SME Work Group
Desired – Future State Model

Q2

Research

D – F State Compatibility with
Trending Technologies

Q3

Research Cont'd

D – F State Compatibility with
Trending Technologies

Q4

Phase 2 End

Deliverable:
D – F State Document
Research Document
Identify and display pros/cons
on trending technologies.

2022

Q1

Phase 3 Implementation

Q2

Q3

Q4

Global Industry Practices Committee (GIPC)

Workplace – Post Pandemic How is it changing?

Russ Dzielak

Director of Channel & Key Accounts,
Phoenix Contact



**Global Industry
Practices Committee**

Sales Interacting with Business Partners and Customers during a Pandemic

has evolved to...

Workplace – Post Pandemic

How is it Changing?



Electronic Components Industry Association

The logo for the Global Industry Practices Committee. It features a large, stylized globe on the right side of the slide, composed of a network of blue and grey dots connected by thin lines, representing a global network. The text "Global Industry Practices Committee" is overlaid on the globe in a bold, blue, sans-serif font, with "Global" and "Committee" underlined.

**Global Industry
Practices Committee**

Sales Interacting with Business Partners and Customers during a Pandemic

Project Objective:

To provide areas for consideration and best practices for how manufacturers, distributors and manufacturer's representatives in the electronic component industry can safely and effectively adapt their selling organizations in response to the Covid-19 pandemic using a combination of remote customer engagement policies and strategies along with guidance regarding face to face selling activities and other external stakeholder meetings.

Work Group:

AVX
Catalyst Unity Solutions
Phoenix Contact
Sager Electric
TTI



Project Deliverables:

1. Best practices document highlighting “areas for consideration” published in **June 2020**
2. Work group continues to meet periodically to review and monitor the pandemic and ever-changing guidelines
3. Work group will determine the best time to publish a follow-up document

April

May

June – Ongoing...

Project Timeline
2020

- ❑ Evolution of the working group towards broader Covid related disruption topics
- ❑ Impacts on shared business experiences range from:
 - Return to work/office/field schedules
 - Customer engagement protocols
 - Observed impacts on productivity
 - New challenges being faced by selling organizations
 - And many more...
- ❑ Current plans include publishing a follow up document on Covid impacts within selling organizations
- ❑ Expanding the working group to broaden input and perspective

PCN (Product Change Notification) Technology Advancements

Don Elario

VP Industry Practice



Electronic Components Industry Association

A large, stylized globe composed of a network of blue and grey dots connected by thin lines, representing a global network or data flow. The globe is positioned on the right side of the slide, partially overlapping the text.

Global Industry
Practices Committee

Environmental Compliance Advisors

ECIA Names GIPC Environmental Compliance Advisors

Atlanta – ECIA is pleased to announce that Carol Parnell, Littelfuse and Dan Carey, Farnell have been named the environmental compliance advisors to the Global Industry Practices Committee (GIPC). ECIA's GIPC recently established these advisory positions to enable ECIA members to gain better awareness about regulations that substantially affect the electronic components industry with the acceleration of global legislation to protect the environment.

Carol Parnell is the Global Director of EHS at Littelfuse and is responsible for the development and execution of the EHS strategy. Currently she is focused on the areas of safety culture, business continuity management, product environmental compliance, and sustainability.

Dan Carey is the Product Compliance Senior Manager at Farnell (dba Farnell, Newark, and element14). He is responsible for Farnell remaining compliant with various product compliance legislations globally and ensures that suppliers provide the required product compliance data.

“These two individuals are highly qualified to advise the GIPC on environmental compliance issues and I am extremely grateful they have stepped up to advise the Committee,” Don Elario, ECIA Vice President of Industry Practices remarked. “The number of environmental regulations that impact the electronic components channel has increased exponentially and we are committed to keeping our members up to date.”



Electronic Components Industry Association

A large graphic on the right side of the slide, depicting a globe with a network of blue dots and lines connecting them, symbolizing global connectivity and technology.

PIP 3.1

CA Prop 65

**Global Industry
Practices Committee**

SCIP Database

Subject Matter Expert Pool

Why *(Participate in the GIPC or a Subject Matter Expert?)*

- Opportunity to Influence
- Impact *Your Company's* Efficiencies and Standardization through Best Practice Awareness
- Collaborate on Common Challenges and Obstacles in *Your Area of Expertise*
- Industry Networking
- Take Advantage of this Talent Development Platform

SME Pool Now “96” Participants

- Join our Quarterly GIPC update webinars
- Receive group emails with news and project activity



Global Industry Practices Committee

Pete Shopp – SVP Business Operations, Mouser Electronics *Co Chair*

Russ Dzielak – Director of Channel & Key Accounts, Phoenix Contact *Co Chair*

Teri Ivaniszyn – VP Operational Excellence, Digi-Key *Past Chair*

Tom Griffin – President, Catalyst Unity Solutions

Dawn Manhart – Director Global Sales Operations, Littelfuse

Kimberly Appleton – SVP Global Sales Operations, ON Semi

Melanie Pizzey – VP Global Business Operations, TTI

Victor Meijers – SVP ECIA

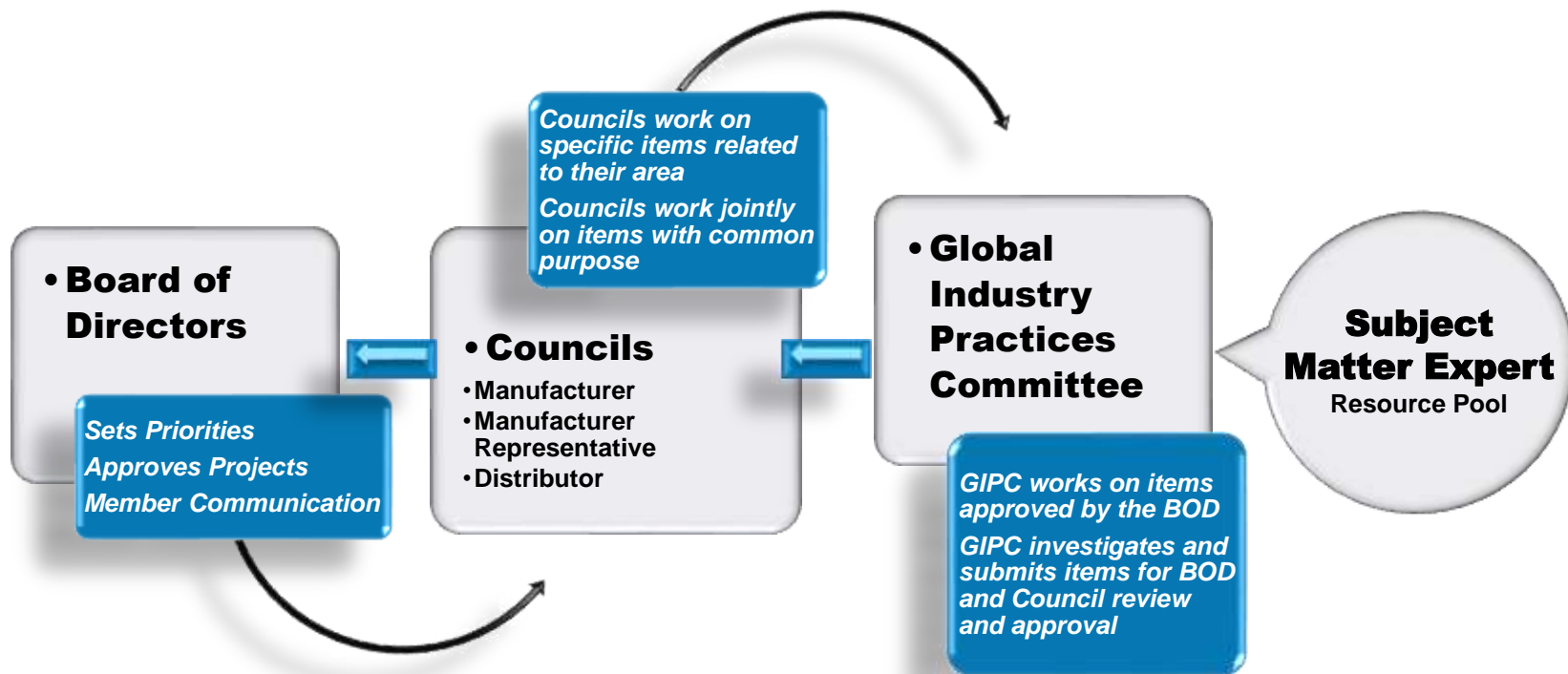
Don Elario – VP Industry Practices ECIA

Subject Matter Expert Pool



Global Industry Practices Committee (GIPC)

How it works today...



Global Industry Practices Committee (GIPC)

Service Partners and 3rd Party Relationships

